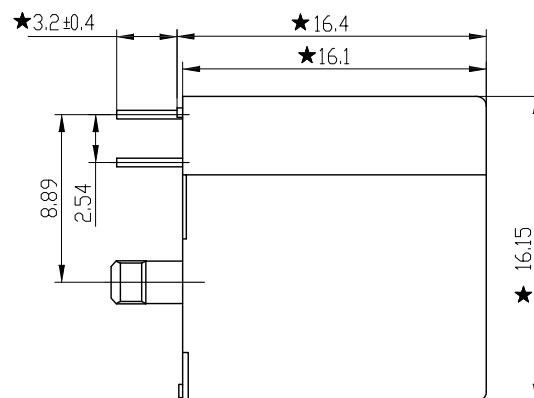
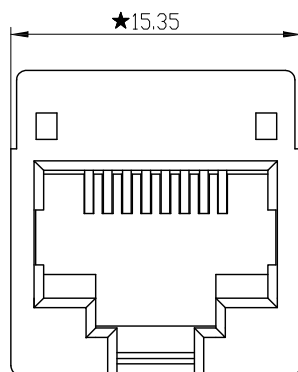


RoHS compliant



NOTES

MATERIAL

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
3. PLATING : GOLD PLATING OVER NICKEL.
FU", 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

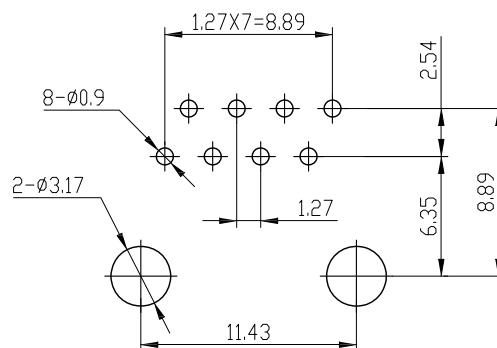
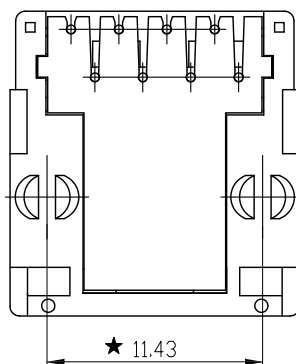
MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$.
2. OPERATION : -40°C TO 85°C .

P/N:RJ52E-8811-000XXXR



PC Board Layout

- GOLD PLATING
1-Gold Flash
2-1u
3-1.5u
4-3u
5-6u
- PLASTIC
1-PBT
2-NYLON66
3-NYLON46
- COLOR
1-BLACK
2-WHITE
3-RED
4-YELLOW

					GENERAL TOLERANCE		DRAWN	Gene Li	2014/03/12	UNIT	MM	X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONICTECHNOLOGY CO., LTD TEL:+86 769 81885389 FAX:+86 769 81887859 E-Mail:sales@x-shun.com Http:www.x-shun.com		
					.X	±0.35 X.° ± 2°	CHECKE	SC		SCALE	1:1			
					.XX	±0.25 .X° ± 1°								
					.XXX	±0.15 .XX° ± 0.5°								
A0		NEW DESIGN	2014/03/12				APPROVE			SHEET	1 OF 1	PART NO.	RJ52E-8811-000XXXR	
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT 		DRAWING NO				REV	A0	TITLE	5224 8P8C 1X1 W/D SHIELD JACK